### Amendments to the Claims:

Cancel claims 1-20.

- 21. A process for photo-fabricating a three-dimensional object by selectively curing a photo-curable resin composition comprising:
- (a) an oxetane having two or more oxetane rings;
- (b) an epoxy compound; and
- (c) a cationic photoinitiator,

#### wherein said process comprises

- (i) forming a layer of said composition;
- (ii) selectively irradiating said layer of said composition to form a solid cured resin layer;
- (iii) forming a layer of said composition on the solid cured resin layer; and
- (iv) repeating steps (ii) and (iii).
- 22. A process for photo-fabricating a three-dimensional object by selectively curing a photo-curable resin composition comprising:
- (a) an oxetane:
- (b) an epoxy compound; and
- (c) a cationic photoinitiator,

### wherein said process comprises

- (i) forming a layer of said composition;
- (ii) selectively irradiating said layer of said composition to form a solid cured resin layer;
- (iii) forming a layer of said composition on the solid cured resin layer; and
- (iv) repeating steps (ii) and (iii);

wherein said oxetane is represented by the following formula (10):

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wherein R represents a hydrogen atom; a fluorine atom; an alkyl group having from 1 to 6 carbon atoms; a fluoroalkyl group having from 1 to 6 carbon atoms; an aryl group having from 6 to 18 carbon atoms; a furyl group; or a thienyl group.

- 23. The process of claim 22, wherein each R represents an alkyl group having from 1 to 6 carbon atoms.
- 24. The process of claim 22, wherein each R represents an ethyl group.
- 25. A process for photo-fabricating a three-dimensional object by selectively curing a photo-curable resin composition comprising:
- (a) an oxetane having 3 or more oxetane rings;
- (b) an epoxy compound; and
- (c) a cationic photoinitiator,

wherein said process comprises

- (i) forming a layer of said composition;
- (ii) selectively irradiating said layer of said composition to form a solid cured resin layer;
- (iii) forming a layer of said composition on the solid cured resin layer; and
- (iv) repeating steps (ii) and (iii).

Cancel claims 26 - 53.

- 54. A composition comprising:
  - (i) an oxetane comprising two or more oxetane rings;
  - (ii) an epoxy compound;

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- (iii) a cationic photoinitiator; and
- (iv) a polyfunctional monomer selected from the group consisting of penta(meth)acrylates and hexa(meth)acrylates.
- 55. The composition of claim 54, wherein said oxetane is represented by the following formula 10:

$$\begin{array}{c}
R \\
O \\
O
\end{array}$$
(10)

wherein R represents a hydrogen atom; a fluorine atom; an alkyl group having from 1 to 6 carbon atoms; a fluoroalkyl group having from 1 to 6 carbon atoms; an aryl group having from 6 to 18 carbon atoms; a furyl group; or a thienyl group.

- 56. The composition of claim 55, wherein each R represents an alkyl group having from 1 to 6 carbon atoms.
- 57. The composition of claim 55, wherein each R represents an ethyl group.
- 58. A composition comprising:
  - (i) an oxetane comprising three or more oxetane rings;
  - (ii) an epoxy compound;
  - (iii) a cationic photoinitiator; and
  - (iv) a polyfunctional monomer selected from the group consisiting of penta(meth)acrylates and hexa(meth)acrylates.

Cancel claims 59 - 67.

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# Statement Under 37 C.F.R. § 1.173 (c)

## Status of the Claims

Claims 21-25 and 54-58 are currently pending. Claims 1-20, 26-53 and 59-67 have been cancelled.